



- Note:**
1. Material:
 - 1.1 Housing: High temperature thermoplastic with g.f, UL94v-0
 - 1.2 Contact: copper alloy, t=0.20mm
 - 1.3 Shell: copper alloy, t=0.25mm
 2. Specification:
 - 2.1 Current rating: 1 A Max.
 - 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
 - 2.3 Contact resistance: 50 mW Max.
 - 2.4 Insulation resistance: 100 M W Min.
 - 2.5 Total mating force: 3.57 Kgf Max.
 - 2.6 Total unmating force: 1.0 Kgf Min. 0.81-2.05 Kgf Min. after 10000 insertion/extraction cycles
 - 2.7 Temperature range: -30° C ~ 80° C

RoHS Compliant		HSM 玄茂科技股份有限公司 HSUAN MAO TECHNOLOGY CO., LTD.	
APPD. 核准 DWG. 製圖 DATE 制表日 2014/7/22	SCALE 比例 UNIT 單位 PAGE 張數 1 OF 1	TOLERANCE 容許公差 0 ± 0.25 ANG. ± SIZE. 線規尺寸 A 4 REV. 版本 A	PART NAME 品名 MICRO USB(1.1) B TYPE 5P FEMALE P.C.B. OFFSET TYPE SMT TYPE SELECTIVE GOLD PLATING BLACK INSULATOR (LCP) REEL PACKING ROHS PART NO. 料號 C8361-05BFDSBRN